

Docket No. _____

Armstrong, Kratz, Quintos, Hanson & Brooks, LLP

DECLARATION FOR U.S. PATENT APPLICATION



As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

PROCESS FOR PRODUCING SOLID ELECTROLYTIC CAPACITOR AND SOLID ELECTROLYTIC CAPACITOR

the specification of which is attached hereto unless the following is checked

was filed on September 11, 2003 as United States Application Number or PCT International Application
Number 10/659,717 and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.

(List prior foreign applications. See note A)	Patent Application		Priority Claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	(Number)	(Country)	
	<u>2002-266465</u>	<u>Japan</u>	<u>12/9/2002</u>
	_____	_____	_____ Yes _____ No
	_____	_____	_____ Yes _____ No
	_____	_____	_____ Yes _____ No
	_____	_____	_____ Yes _____ No
	_____	_____	_____ Yes _____ No

(See note B) _____ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List prior U.S. Applications)			Status <input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	(Application Serial No.)	(Filing Date)	
	_____	_____	_____ Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	_____	_____	_____ Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	_____	_____	_____ Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	_____	_____	_____ Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	_____	_____	_____ Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number

23850

PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

Customer Number

23850

PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C) Full name of sole or first inventor (given name, family name) Eizo FUJII

Inventor's Signature Eizo FUJII Date January 15, 2004

Residence Hirakata-shi, Osaka, Japan Citizenship Japanese

Post Office Address 1-6-29, Tsudaekimae, Hirakata-shi, Osaka 573-0125, Japan

Full name of second inventor (given name, family name) Hideki ISHIDA

Inventor's Signature Hideki ISHIDA Date January 15, 2004

Residence Takasago-shi, Hyogo, Japan Citizenship Japanese

Post Office Address 70-7, Kitaike, Amidacho, Takasago-shi, Hyogo 676-0825, Japan

Full name of third inventor (given name, family name)

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of fourth inventor (given name, family name)

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of fifth inventor (given name, family name)

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of sixth inventor (given name, family name)

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

NOTES

- A. Please list all foreign applications relating to the invention and check "yes" or "no."
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate city and state, for residence outside the U.S., indicate city and country. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.